PD - 95313

International

IRFP244PbF

 $V_{\text{DSS}} = 250 V$

 $I_{\rm D} = 15A$

 $R_{DS(on)} = 0.28\Omega$

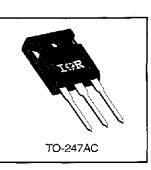
HEXFET[®] Power MOSFET

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Lead-Free

Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-247 package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220 devices. The TO-247 is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.



Absolute Maximum Ratings

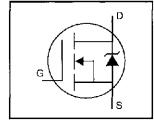
| | Parameter | Max. | Units | |
|---|--|--------------------------------|-------|--|
| I _D @ T _C = 25°C | Continuous Drain Current, V _{GS} @ 10 V | 15 | | |
| I _D @ T _C = 100°C | Continuous Drain Current, VGS @ 10 V | 9.7 | A. | |
| Том | Pulsed Drain Current ① | 60 | | |
| P _D @ T _C = 25°C | Power Dissipation | 150 | w | |
| | Linear Derating Factor | 1.2 | W/°C | |
| Vgs | Gate-to-Source Voltage | ±20 | V | |
| Eas | Single Pulse Avalanche Energy ② | 550 | mJ | |
| lan | Avalanche Current ① | 15 | A | |
| EAR | Repetitive Avalanche Energy ① | 15 | mJ | |
| dv/dt | Peak Diode Recovery dv/dt ③ | 4.8 | V/ns | |
| TJ | Operating Junction and | -55 to +150 | | |
| Тѕтс | Storage Temperature Range | | °C | |
| | Soldering Temperature, for 10 seconds | 3 <u>00 (</u> 1.6mm from case) | | |
| | Mounting Torque, 6-32 or M3 screw | 10 lbf+in (1.1 N+m) | | |

Thermal Resistance

| | Parameter | Min. | Тур. | Max. | Units |
|------|-------------------------------------|------|------|------|-------|
| Rejc | Junction-to-Case | | — | 0.83 | |
| Recs | Case-to-Sink, Flat, Greased Surface | | 0.24 | _ | °C/W |
| Roja | Junction-to-Ambient | — | — | 40 | 1 |

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| | Parameter | Min. | Тур. | Max. | Units | Test Conditions |
|---------------------------------|--------------------------------------|------|------|------|-------|---|
| V(BR)DSS | Drain-to-Source Breakdown Voltage | 250 | | | V | V _{GS} =0V, I _D = 250μA |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient | - | 0.37 | — | V/°C | Reference to 25°C, I _D = 1mA |
| R _{DS(on)} | Static Drain-to-Source On-Resistance | | - | 0.28 | Ω | V _{GS} =10V, I _D =9.0A ④ |
| V _{GS(th)} | Gate Threshold Voltage | 2.0 | ; — | 4.0 | V | V _{DS} =V _{GS} , I _D = 250μA |
| ğ fs | Forward Transconductance | 6.7 | | | S | V _{DS} =50V, I _D =9.0A ④ |
| ! | Drain-to-Source Leakage Current | - | — | 25 | | V _{DS} =250V, V _{GS} =0V |
| loss | Drain-to-Source Leakage Current | - | — | 250 | μA | V _{DS} =200V, V _{GS} =0V, T _J =125°C |
| 1 | Gate-to-Source Forward Leakage | — | — | 100 | nA | V _{GS} =20V |
| lass | Gate-to-Source Reverse Leakage | | | -100 | ПА | V _{GS} =-20V |
| Q, | Total Gate Charge | — | — | 63 | | ID=11A |
| Qgs | Gate-to-Source Charge | | - | 12 | nC | V _{DS} =200V |
| Q _{gd} | Gate-to-Drain ("Miller") Charge | | _ | 39 | | $V_{\rm GS}\text{=}10V$ See Fig. 6 and 13 \circledast |
| t _{d(on)} | Tum-On Delay Time | — | 14 | . — | | V _{DD} =125V |
| tr | Rise Time | — | 49 | | ns | ID=11A |
| t _{d(off)} | Tum-Off Delay Time | - | 42 | | 113 | R _θ =9.1Ω |
| t _f | Fall Time | - | 24 | _ | | R _D =11Ω See Figure 10 @ |
| LD | Internal Drain Inductance | - | 5.0 | _ | nH | Between lead, 6 mm (0.25in.) |
| L _S | Internal Source Inductance | _ | 13 | _ | | from package and center of die contact |
| Ciss | Input Capacitance | _ | 1400 | _ | | V _{CS} =0V |
| Coss | Output Capacitance | _ | 320 | | рF | V _{DS} = 25V |
| Crss | Reverse Transfer Capacitance | | 73 | _ |] | f=1.0MHz See Figure 5 |

Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

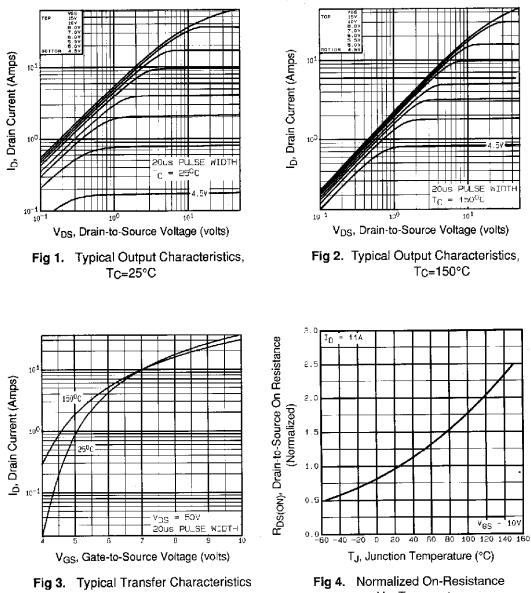
Source-Drain Ratings and Characteristics

| | Parameter | Min. | Typ. | Max. | Units | Test Conditions | |
|-----------------|---|----------|--|------|-------|--|--|
| Is | Continuous Source Current (Body Diode) | | - | 15 | Α | MOSFET symbol showing the | |
| Ism | Pulsed Source Current (Body Diode) ① | _ | _ | 60 | | p-n junction diode. | |
| V _{SD} | Diode Forward Voltage | | - | 1.8 | V | T _J =25°C, I _S =15A, V _{GS} =0V ④ | |
| trr | Reverse Recovery ⊺ime | | 290 | 570 | ns | T_=25°C, I==11A | |
| Qrr | Reverse Recovery Charge | — | 3.1 | 6.3 | μC | di/dt=100A/µs ④ | |
| t _{on} | Forward Turn-On Time | Intrinsi | Intrinsic turn-on time is neglegible (turn-on is dominated by $L_{S}+L_{D})$ | | | | |

Notes:

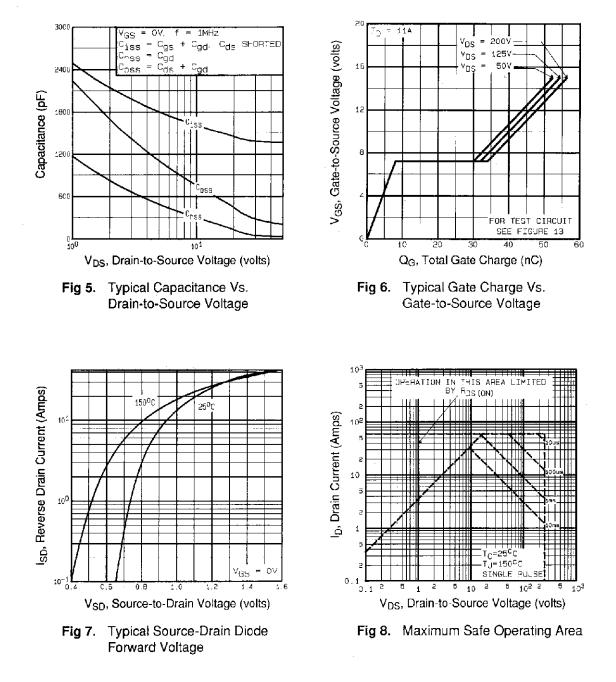
- ① Repetitive rating; pulse width limited by max. junction temperature (See Figure 11)
- V_{DD}=50V, starting T_J=25°C, L=3.9mH R_G=25Ω, I_{AS}=15A (See Figure 12)
- $\textcircled{\sc sc star}$ Isd≤15A, di/dt≤150A/µs, Vdd≤V(BR)dss, TJ≤150°C
- ④ Pulse width \leq 300 μ s; duty cycle \leq 2%.

International **ISPR** Rectifier

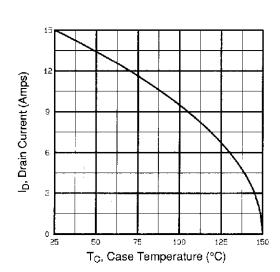


Vs. Temperature

International

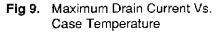


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International

ICR Rectifier



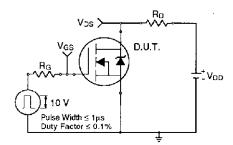


Fig 10a. Switching Time Test Circuit

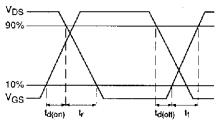


Fig 10b. Switching Time Waveforms

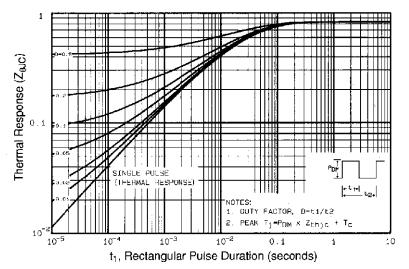
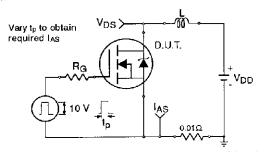
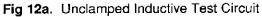


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

International





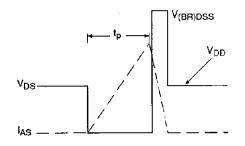


Fig 12b. Unclamped Inductive Waveforms

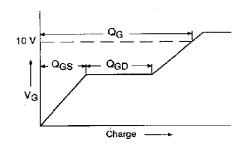


Fig 13a. Basic Gate Charge Waveform

1200 ן 6.7A 9.5A r o P воттом 15A 1000 EAS, Single Pulse Energy (mJ) 800 500 400 200 507 VoD 0 25 50 75 100 125 150 Starting T_J, Junction Temperature(°C)

Fig 12c. Maximum Avalanche Energy Vs. Drain Current

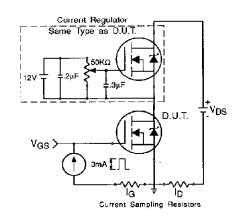


Fig 13b. Gate Charge Test Circuit

Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit - See page 1505



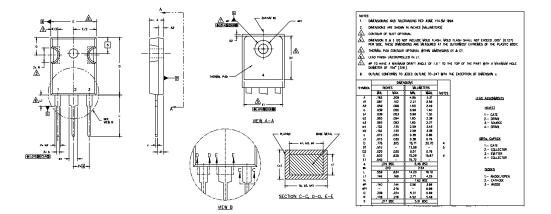
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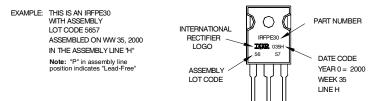
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TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



TO-247AC Part Marking Information



Data and specifications subject to change without notice.

International

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